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Small / Slim Object Detection NA1-11 Metal-sheet

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GD

Other Products

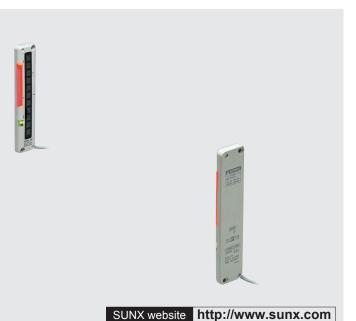
# Small / Slim Object Detection Area Sensor

# NA1-11

Related Information

 ■ Sensor selection guide ..... P.11~ / P.727~

■ General precautions ......P.986~









Make sure to use light curtains when using a sensing device for personnel protection. Refer to p.477~ for light curtains.



# Cross-beam scanning system to detect slim objects

# Letter or visiting card detectable!

Slim objects can be detected by using the cross-beam scanning system.



### Emitting and receiving element pitch: 10 mm 0.394 in

A minimum sensing object size of ø13.5 mm ø 0.531 in is realized by using an emitting and receiving element pitch of 10 mm 0.394 in.



#### Wide area

Though being very slim, it realizes a wide sensing area of 1 m 3.281 ft length and 100 mm 3.937 in width. It is most suitable for object detection on a wide assembly line, or for detecting the dropping of, or incursion by, small objects whose travel path is uncertain.



# Just 10 mm 0.394 in thick

It is extremely slim, being just 10 mm 0.394 in thick. Further, it can be mounted in a narrow space since you can select from two cable orientation directions.



It is possible to select from two cable orientation directions.

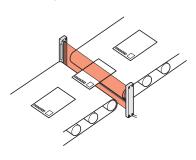
## Globally useable

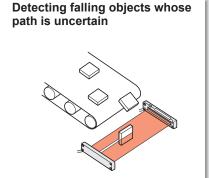
It conforms to the EMC Directive and has UL Recognition. Moreover, PNP output type, which is much in demand in Europe, is also available.



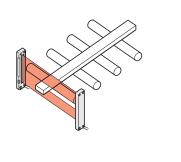
### **APPLICATIONS**

### **Detecting post-cards**





# Detecting edge of moving object

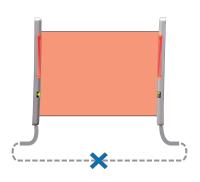




Never use this product in any personnel safety application.

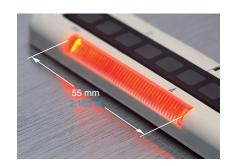
## No synchronization wire

Wiring is saved and made simple as no synchronization wire is required between the emitter and the receiver.



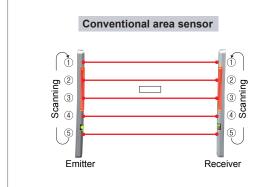
# **Clearly visible indicator**

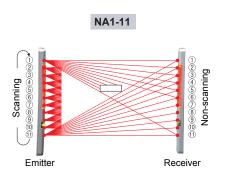
A clearly visible large indicator, having a 55 mm 2.165 in width, is incorporated on both the emitter and the receiver. Further, if the sensing output is directly connected to the large indicator input, the indicator can be conveniently used as a large operation indicator. Moreover, its operation can be selected as lighting or blinking.



### **Cross-beam Scanning System**

In a conventional area sensor, slim objects cannot be detected since the emitting and the receiving elements are scanned, synchronously, as a set. In contrast, in NA1-11, only the elements ① to ⑪ of the emitter are scanned to obtain emission. The elements of the receiver are not scanned, so that when element ① of the emitter emits light, all the elements of the receiver receive light. Hence, even if there is one element on the receiver which does not receive light, it results in light interrupted operation. With this technique, detection of slim objects is possible.





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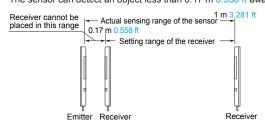
MEASURE-MENT SENSORS STATIC CONTROL DEVICES

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# **ORDER GUIDE**

Туре	Appearance	Sensing range (Note1)	Model No.(Note2)	Output
NPN output	Sensing height:	0.17 to 1 m 0.558 to 3.281 ft	NA1-11	NDN open collector transistar
5 m 16.404 ft cable length	400 0 007 :		NA1-11-C5	NPN open-collector transistor
PNP output	No. of elements per emitter / pitch: 10 mm receiver: 11 0.394 in		NA1-11-PN	PNP open-collector transistor

Notes: 1) The sensing range is the possible setting distance between the emitter and the receiver. The sensor can detect an object less than 0.17 m 0.558 ft away.



2) The model No. with suffix "P" shown on the label affixed to the product is the emitter, "D" shown on the label is the receiver. (e.g.) Emitter of NA1-11: NA1-11P, Receiver of NA1-11: NA1-11D

# **OPTIONS**

Designation	Model No.	Description	
Sensor	MS-NA1-1	Four bracket set  Four M4 (length 15 mm 0.591 in) screws with washers, eight nuts, four hooks, four spacers and eight M4 (length 18 mm 0.709 in) screws with washers are attached. (Spacers are not attached with MS-NA1-1.)	
mounting bracket			

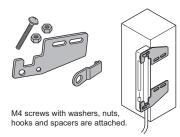
### Sensor mounting bracket

• MS-NA1-1



M4 screws with washers, nuts and hooks are attached.

#### • MS-NA2-1



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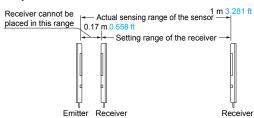
GD Other Products

## **SPECIFICATIONS**

		Туре	NPN output	PNP output	
Item	n Mode	l No.	NA1-11	NA1-11-PN	
Sensing height			100 mm 3.937 in		
Sensing range (Note 2)			0.17 to 1 m 0.558 to 3.281 ft		
Elen	nent pitch		10 mm 0.394 in		
Number of emitting / receiving elements		ving	11 Nos. each on the emitter and the receiver, respectively		
Sensing object			ø13.5 mm ø0.531 in or more opaque object (Note 3)		
Supp	oly voltage		12 to 24 V DC ± 10 % Ripple P-P 10 % or less		
Curr	ent consumption		Emitter: 80 mA or less, Receiver: 100 mA or less		
Output			NPN open-collector transistor  • Maximum sink current: 100 mA  • Applied voltage: 30 V DC or less (between output and 0 V)  • Residual voltage: 1 V or less (at 100 mA sink current)  0.4 V or less (at 16 mA sink current)	PNP open-collector transistor  • Maximum source current: 100 mA  • Applied voltage: 30 V DC or less (between output and +V  • Residual voltage: 1 V or less (at 100 mA source current)  0.4 V or less (at 16 mA source current	
	Utilization category		DC-12 (	pr DC-13	
	Output operation		ON or OFF when beam channel is interru	pted, selectable by operation mode switch	
	Short-circuit protecti	on	Incorp	porated	
Res	oonse time		In Dark state: 5 ms or less,	In Light state: 10 ms or less	
Indicators	Emitter		Power indicator: Green LED (lights up when the power is ON) Large indicator: Orange LED / lights up or blinks when the \ large indicator input is Low, \ lighting pattern is selected \ by operation mode switch	Power indicator: Green LED (lights up when the power is ON) Large indicator: Orange LED / lights up or blinks when the large indicator input is High, lighting pattern is selected by operation mode switch	
	Receiver		Operation indicator: Orange LED (lights up when the output is ON) Power indicator: Green LED (lights up when the power is ON) Large indicator: Orange LED / lights up or blinks when the large indicator input is Low, lighting pattern is selected by operation mode switch	Operation indicator: Orange LED (lights up when the output is ON) Power indicator: Green LED (lights up when the power is ON) Large indicator: Orange LED / lights up or blinks when the large indicator input is High, lighting pattern is selected by operation mode switch	
	Pollution degree		3 (Industrial environment)		
	Protection		IP62 (IEC) (Refer to p.984 for details of standards)		
)Ce	Ambient temperatur	Э	-10 to 55 °C +14 to +131 °F (No dew condensation or icing allowed), Storage: -20 to +70 °C -4 to +158 °F		
Environmental resistance	Ambient humidity		35 to 85 % RH, Storage: 35 to 85 % RH		
al res	Ambient illuminance		Incandescent light: 3,000 ℓx at the light-receiving face		
nent	EMC		EN 60947-5-2		
iron	Voltage withstandab	ility	1,000 V AC for one min. between all supply terminals connected together and enclosure		
Envi	Insulation resistance	;	20 MΩ, or more, with 250 V DC megger between all supply terminals connected together and enclosure		
	Vibration resistance		10 to 150 Hz frequency, 1.5 mm 0.059 in amplitude in X, Y and Z directions for two hours each		
	Shock resistance		500 m/s² acceleration (50 G approx.) in X, Y and Z directions for three times each		
Emitting element			Infrared LED (Peak emission wavelength: 880nm 0.035mil, cross-beam scanning system)		
Material			Enclosure: Heat-resistant ABS, Lens: Acrylic, Indicator cover: Acrylic		
Cable			0.3 mm² 4-core (emitter: 3-core) oil resistant cabtyre cable, 2 m 6.562 ft long		
Cable extension			Extension up to total 100 m 328.084 ft is possible, for both emitter and receiver, with 0.3 mm², or more, cable.		
Weight			Net weight: Emitter 80 g approx., Receiver 85 g approx, Gross Weight: 210 g approx.		

Notes: 1) Where measurement conditions have not been specified precisely, the conditions used were an ambient temperature of +23 °C +73.4 °F

2) The sensing range is the possible setting distance between the emitter and the receiver. The sensor can detect an object less than 0.17 m 0.558 ft



3) Although this product can detect slim objects by using the cross-beam scanning system, the size of the slim object which can be stably detected differs with the setting distance. When this sensor is used to detect slim objects, make sure to confirm stable detection using the actual objects.

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# I/O CIRCUIT AND WIRING DIAGRAMS

NA1-11 NPN output type

Input

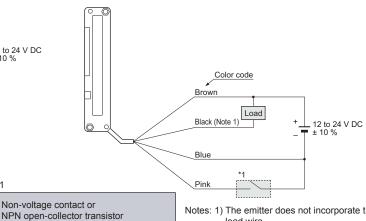
#### I/O circuit diagram Color code (Brown) +V (Black) Output (Note 1) 12 to 24 V DC ± 10 % Sensor circuit 100 mA max **☆** Z<sub>D</sub> (Blue) 0 V Large indicator lighting / blinking circuit (Pink) Input **▼**E Internal circuit ← → Users' circuit

Notes: 1) The emitter does not incorporate the output

2) Unused wires must be insulated to ensure that they do not come into contact with wires already in use.

Symbols  $\dots$  D : Reverse supply polarity protection diode ZD: Surge absorption zener diode Tr : NPN output transistor E : Large indicator (INDICATOR)

# Wiring diagram



Notes: 1) The emitter does not incorporate the black lead wire.

> 2) Unused wires must be insulated to ensure that they do not come into contact with wires already in use.

> > PNP output type

High (5 to 30 V, or open): Lights off

# I/O circuit diagram

**NA1-11-PN** 

#### Color code (Brown) +V **∡**Z⊳ Tr J circuit 100 mA max 12 to 24 V DC (Black) Output (Note) Load Sensor (Blue) 0 V Large indicator lighting / blinking circuit (Pink) Input **\$** € E Internal circuit ← → Users' circuit

Notes: 1) The emitter does not incorporate the output (black).

2) Unused wires must be insulated to ensure that they do not come into contact with wires already in use.

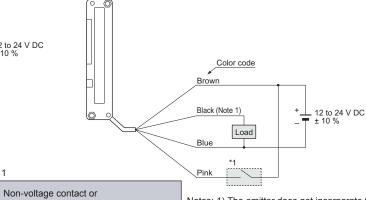
Symbols ... D : Reverse supply polarity protection diode ZD: Surge absorption zener diode

Tr: PNP output transistor

E: Large indicator (INDICATOR)

## Wiring diagram

Low (0 to 2 V): Lights up or blinks



PNP open-collector transistor

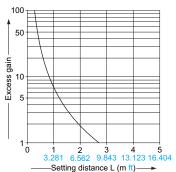
Low (4 V or more): Lights up or blinks High (0 to 0.6 V, or open): Lights off

Notes: 1) The emitter does not incorporate the black

2) Unused wires must be insulated to ensure that they do not come into contact with wires already in use.

# **SENSING CHARACTERISTICS (TYPICAL)**

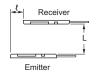
#### Correlation between setting distance and excess gain



# SENSING CHARACTERISTICS (TYPICAL)

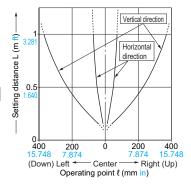
#### Parallel deviation

#### **Vertical direction**



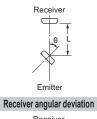
#### **Horizontal direction**



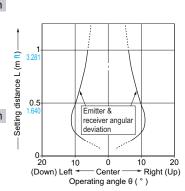


#### Angular deviation

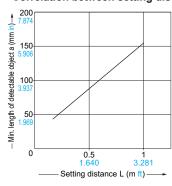
# Emitter angular deviation



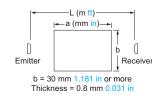




#### Correlation between setting distance and minimum length of detectable object



The minimum length of the detectable object, which lies in a plane perpendicular to the sensor front surface, varies with the setting distance, as shown in the left graph. However, note that the minimum length of the detectable object also varies with the object thickness.



\* The sensing object is considered to be placed at the center of the sensing area.

# PRECAUTIONS FOR PROPER USE

Refer to p.986~ for general precautions.

· Never use this product as a sensing device for personnel protection.

 For sensing devices to be used as safety devices for press machines or for personnel protection, use products which meet laws and standards, such as OSHA, ANSI or IEC etc., for personnel protection applicable in each region or country.

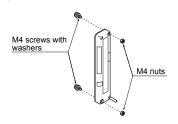
- · If this product is used as a sensing device for personnel protection, death or serious body injury could result.
- · For a product which meets safety standards, use the following products.

Type 4: **SF4B** series (P.481~)

Type 2: SF2B series (P.515~)

#### Mounting

• Use M4 screws with washers and M4 nuts. The tightening torque should be 0.5 N·m or less. (Please arrange the screws and nuts separately.)



### Selection of large indicator operation

· Lighting / Blinking is selected by the operation mode switch on the emitter and the receiver.

Operation of	Operation mode switch		
large indicator	Emitter	Receiver	
Lighting	LIGHT BLINK	LIGHT BLINK	
Blinking	LIGHT BLINK	LIGHT BLINK	

#### Selection of output operation

• The output operation mode is selected by the operation mode switch on the receiver.

The switches must be set with the power supply off. The operation mode does not change if the switch setting is changed with the power supplied.

Operation mode switch (Receiver)		Output operation	Operation indicator (Orange)
D-ON	D/ON L/ON	ON in Dark state	Lights up when the output is ON
L-ON	D/ON L/ON	OFF in Dark state	Lights up when the output is ON

Note: LIGHT / BLINK switch is not related to the output operation selection.

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Liquid Leak Detection

EX-F70 EX-F60

Liquid Level Detection

EX-F1

Color Mark Detection

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Product

SUNX

PRECAUTIONS FOR PROPER USE

Refer to p.986~ for general precautions.

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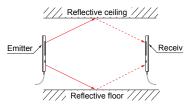
Liquid Level Detection

EX-F1
Color Mark
Detection

Wafer

**Others** 

- Do not use during the initial transient time (0.5 sec.) after the power supply is switched on.
- Although this sensor can detect slim objects by using the cross-beam scanning system, the size of the slim object which can be stably detected differs with the setting distance. Hence, when the sensor is used to detect slim objects, make sure to confirm stable detection using the actual objects.
- In case of this sensor, light from the emitter spreads above and below the sensor. Hence, take care that if there is a reflective object above or below the sensor it will affect the sensing.

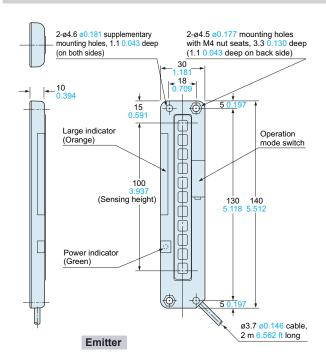


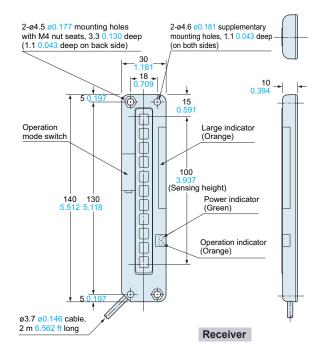
\* Refer to "Parallel deviation" on p.768.

DIMENSIONS (Unit: mm in) The CAD data in the dimensions can be downloaded from the SUNX website: http://www.sunx.com

## NA1-11 NA1-11-PN

Sensor





FZ-10
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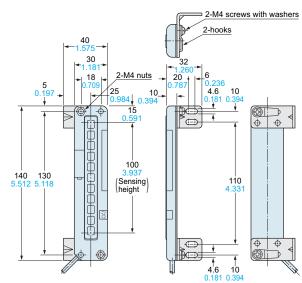
# DIMENSIONS (Unit: mm in) The CAD data in the dimensions can be downloaded from the SUNX website: http://www.sunx.com

#### MS-NA1-1

### Sensor mounting bracket (Optional)

#### **Assembly dimensions**

Mounting drawing with the receiver



Material: Cold rolled carbon steel (SPCC) (Uni-chrome plated)

ς <mark>0.7</mark>υ

Four bracket set

Four M4 (length 15 mm 0.591 in) screws with washers, eight nuts, four hooks and eight M4 (length 18 mm 0.709 in) screws with washers are attached.

M4 (length 18 mm 0.709 in) screws with washers are not used for NA1-11.

4.6 10 4.6 0.18

30

4-ø4.6

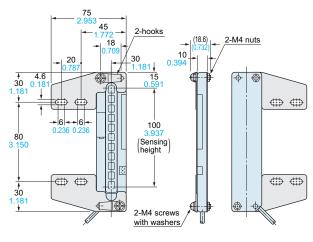
holes

MS-NA2-1

Sensor mounting bracket (Optional)

# **Assembly dimensions**

Mounting drawing with the receiver



Material: Cold rolled carbon steel (SPCC) (Uni-chrome plated)

Four bracket set

Four M4 (length 15 mm 0.591 in) screws with washers, eight nuts, four hooks, four spacers and eight M4 (length 18 mm 0.709 in) screws with washers are attached.

45 77

30

18 0.709

20

2-ø4.6 ø0.181 holes

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